



# STP45NF06L STB45NF06L

N-CHANNEL 60V - 0.022Ω - 38A TO-220 / D<sup>2</sup>PAK  
STripFET™ II POWER MOSFET

| TYPE       | V <sub>DSS</sub> | R <sub>D(on)</sub> | I <sub>D</sub> |
|------------|------------------|--------------------|----------------|
| STP45NF06L | 60 V             | < 0.028Ω           | 38 A           |
| STB45NF06L | 60 V             | < 0.028Ω           | 38 A           |

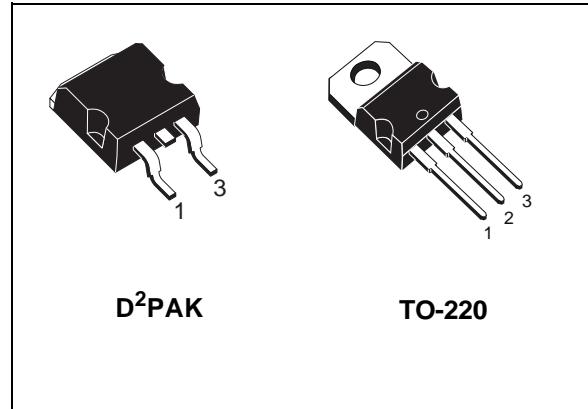
- TYPICAL R<sub>D(on)</sub> = 0.022Ω
- EXCEPTIONAL dv/dt CAPABILITY
- LOGIC LEVEL GATE DRIVE

## DESCRIPTION

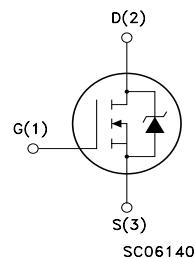
This Power Mosfet is the latest development of STMicroelectronics unique "Single Feature Size™" strip-based process. The resulting transistor shows extremely high packing density for low on-resistance, rugged avalanche characteristics and less critical alignment steps therefore a remarkable manufacturing reproducibility.

## APPLICATIONS

- HIGH-EFFICIENCY DC-DC CONVERTERS
- SOLENOID AND RELAY DRIVERS
- MOTOR CONTROL, AUDIO AMPLIFIERS
- DC-DC & DC-AC CONVERTERS



INTERNAL SCHEMATIC DIAGRAM



## ABSOLUTE MAXIMUM RATINGS

| Symbol              | Parameter   | Value      | Unit |
|---------------------|---|------------|------|
| V <sub>DS</sub>     | Drain-source Voltage (V <sub>GS</sub> = 0)          | 60         | V    |
| V <sub>DGR</sub>    | Drain-gate Voltage (R <sub>GS</sub> = 20 kΩ)        | 60         | V    |
| V <sub>GS</sub>     | Gate- source Voltage                                | ±16        | V    |
| I <sub>D</sub>      | Drain Current (continuos) at T <sub>C</sub> = 25°C  | 38         | A    |
| I <sub>D</sub>      | Drain Current (continuos) at T <sub>C</sub> = 100°C | 26         | A    |
| I <sub>DM (•)</sub> | Drain Current (pulsed)                              | 152        | A    |
| P <sub>TOT</sub>    | Total Dissipation at T <sub>C</sub> = 25°C          | 80         | W    |
|                     | Derating Factor                                     | 0.53       | W/°C |
| dv/dt (1)           | Peak Diode Recovery voltage slope                   | 7          | V/ns |
| T <sub>stg</sub>    | Storage Temperature                                 | -55 to 175 | °C   |
| T <sub>j</sub>      | Max. Operating Junction Temperature                 |            |      |

(•) Pulse width limited by safe operating area

(1) I<sub>SD</sub> ≤ 38A, di/dt ≤ 300A/μs, V<sub>DD</sub> ≤ V<sub>(BR)DSS</sub>, T<sub>j</sub> ≤ T<sub>JMAX</sub>.

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### THERMAL DATA

|                |  |      |      |
|----------------|--|------|------|
| Rthj-case      | Thermal Resistance Junction-case Max           | 1.87 | °C/W |
| Rthj-amb       | Thermal Resistance Junction-ambient Max        | 62.5 | °C/W |
| T <sub>l</sub> | Maximum Lead Temperature For Soldering Purpose | 300  | °C   |

### AVALANCHE CHARACTERISTICS

| Symbol          | Parameter   | Max Value | Unit |
|-----------------|---|-----------|------|
| I <sub>AR</sub> | Avalanche Current, Repetitive or Not-Repetitive<br>(pulse width limited by T <sub>j</sub> max)                                | 38        | A    |
| E <sub>AS</sub> | Single Pulse Avalanche Energy<br>(starting T <sub>j</sub> = 25 °C, I <sub>D</sub> = I <sub>AR</sub> , V <sub>DD</sub> = 50 V) | 135       | mJ   |

### ELECTRICAL CHARACTERISTICS (TCASE = 25 °C UNLESS OTHERWISE SPECIFIED) OFF

| Symbol           | Parameter   | Test Conditions   | Min. | Typ. | Max.    | Unit     |
|------------------|---|---|------|------|---------|----------|
| V(BR)DSS         | Drain-source Breakdown Voltage                        | I <sub>D</sub> = 250 μA, V <sub>GS</sub> = 0  | 60   |      |         | V        |
| I <sub>DSS</sub> | Zero Gate Voltage Drain Current (V <sub>GS</sub> = 0) | V <sub>DS</sub> = Max Rating<br>V <sub>DS</sub> = Max Rating, T <sub>C</sub> = 125 °C |      |      | 1<br>10 | μA<br>μA |
| I <sub>GSS</sub> | Gate-body Leakage Current (V <sub>DS</sub> = 0)       | V <sub>GS</sub> = ±16V  |      |      | ±100    | nA       |

### ON (1)

| Symbol              | Parameter                         | Test Conditions  | Min. | Typ.           | Max.          | Unit |
|---------------------|-----------------------------------|--|------|----------------|---------------|------|
| V <sub>GS(th)</sub> | Gate Threshold Voltage            | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>D</sub> = 250 μA                                  | 1    | 1.7            | 2.5           | V    |
| R <sub>DS(on)</sub> | Static Drain-source On Resistance | V <sub>GS</sub> = 5 V, I <sub>D</sub> = 19 A<br>V <sub>GS</sub> = 10V, I <sub>D</sub> = 19 A |      | 0.024<br>0.022 | 0.03<br>0.028 | Ω    |

### DYNAMIC

| Symbol              | Parameter                    | Test Conditions                                       | Min. | Typ. | Max. | Unit |
|---------------------|------------------------------|---|------|------|------|------|
| g <sub>fs</sub> (1) | Forward Transconductance     | V <sub>DS</sub> = 15V, I <sub>D</sub> = 19 A          |      | 24   |      | S    |
| C <sub>iss</sub>    | Input Capacitance            | V <sub>DS</sub> = 25V, f = 1 MHz, V <sub>GS</sub> = 0 |      | 1600 |      | pF   |
| C <sub>oss</sub>    | Output Capacitance           |   |      | 217  |      | pF   |
| C <sub>rss</sub>    | Reverse Transfer Capacitance |   |      | 62   |      | pF   |

## ELECTRICAL CHARACTERISTICS (CONTINUED)

### SWITCHING ON

| Symbol      | Parameter          | Test Conditions   | Min. | Typ. | Max. | Unit |
|-------------|--------------------|---|------|------|------|------|
| $t_{d(on)}$ | Turn-on Delay Time | $V_{DD} = 30V, I_D = 19A$                                       |      | 30   |      | ns   |
| $t_r$       | Rise Time          | $R_G = 4.7\Omega, V_{GS} = 10V$<br>(see test circuit, Figure 3) |      | 105  |      | ns   |
| $Q_g$       | Total Gate Charge  | $V_{DD} = 48V, I_D = 38A,$                                      |      | 23   |      | nC   |
| $Q_{gs}$    | Gate-Source Charge | $V_{GS} = 5V$   |      | 7    |      | nC   |
| $Q_{gd}$    | Gate-Drain Charge  |   |      | 10   |      | nC   |

### SWITCHING OFF

| Symbol       | Parameter             | Test Conditions   | Min. | Typ. | Max. | Unit |
|--------------|-----------------------|---|------|------|------|------|
| $t_{d(off)}$ | Turn-off-Delay Time   | $V_{DD} = 30V, I_D = 19A,$                                      |      | 65   |      | ns   |
| $t_f$        | Fall Time             | $R_G = 4.7\Omega, V_{GS} = 10V$<br>(see test circuit, Figure 3) |      | 25   |      | ns   |
| $t_d(off)$   | Off-voltage Rise Time | $V_{clamp} = 48V, I_D = 38A$                                    |      | 50   |      | ns   |
| $t_f$        | Fall Time             | $R_G = 4.7\Omega, V_{GS} = 10V$                                 |      | 55   |      | ns   |
| $t_c$        | Cross-over Time       | (see test circuit, Figure 5)                                    |      | 85   |      | ns   |

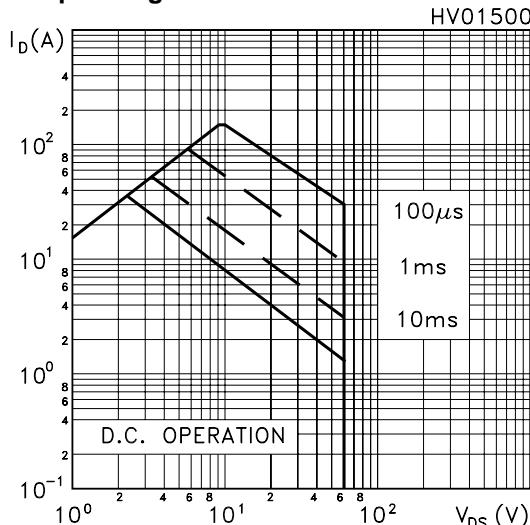
### SOURCE DRAIN DIODE

| Symbol       | Parameter                     | Test Conditions                    | Min. | Typ. | Max. | Unit |
|--------------|-------------------------------|------------------------------------|------|------|------|------|
| $I_{SD}$     | Source-drain Current          |                                    |      |      | 38   | A    |
| $I_{SDM}(2)$ | Source-drain Current (pulsed) |                                    |      |      | 152  | A    |
| $V_{SD}(1)$  | Forward On Voltage            | $I_{SD} = 38A, V_{GS} = 0$         |      |      | 1.5  | V    |
| $t_{rr}$     | Reverse Recovery Time         | $I_{SD} = 38A, di/dt = 100A/\mu s$ |      | 70   |      | ns   |
| $Q_{rr}$     | Reverse Recovery Charge       | $V_{DD} = 100V, T_j = 150^\circ C$ |      | 110  |      | nC   |
| $I_{RRM}$    | Reverse Recovery Current      | (see test circuit, Figure 5)       |      | 4    |      | A    |

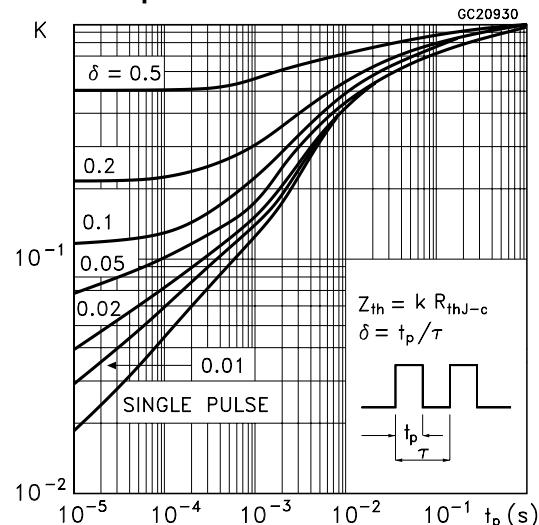
Note: 1. Pulsed: Pulse duration = 300  $\mu s$ , duty cycle 1.5 %.

2. Pulse width limited by safe operating area.

### Safe Operating Area

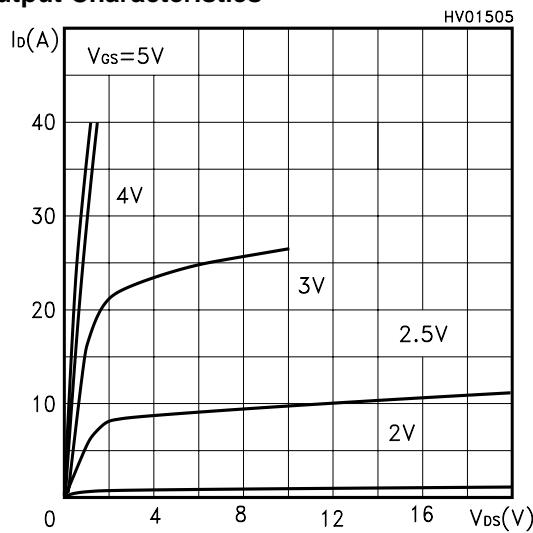


### Thermal Impedance

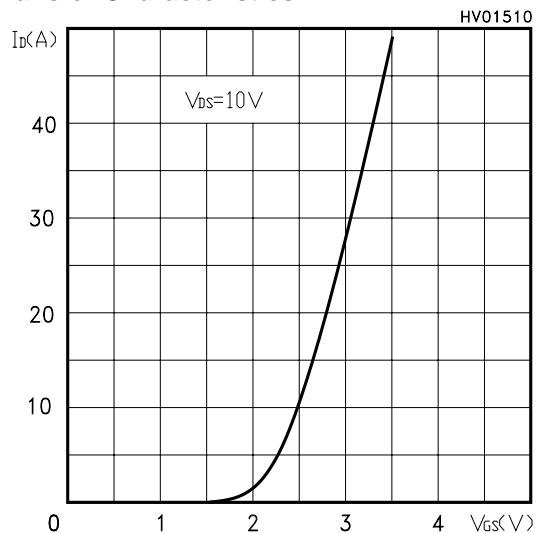


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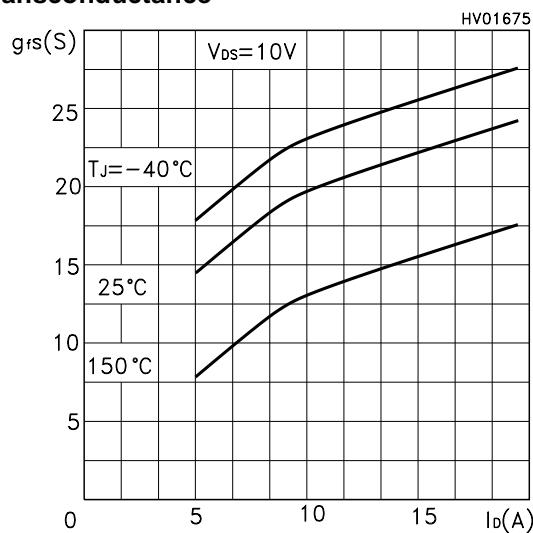
### Output Characteristics



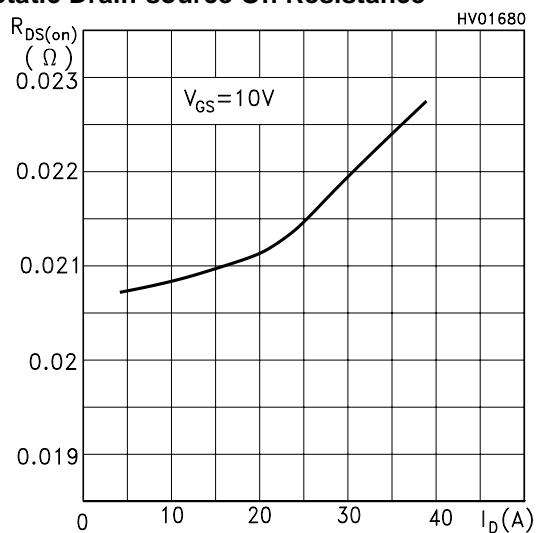
### Transfer Characteristics



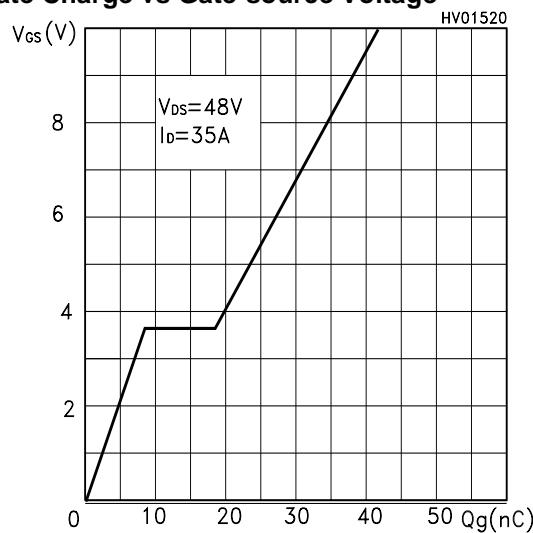
### Transconductance



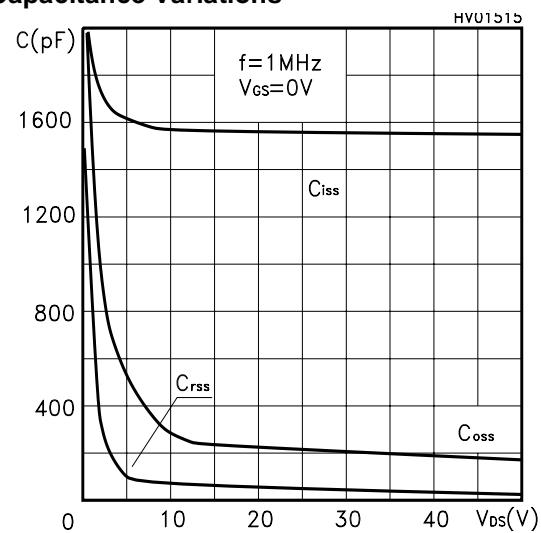
### Static Drain-source On Resistance



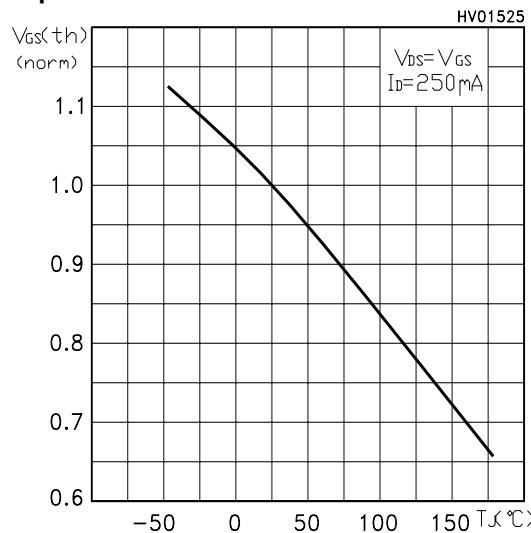
### Gate Charge vs Gate-source Voltage



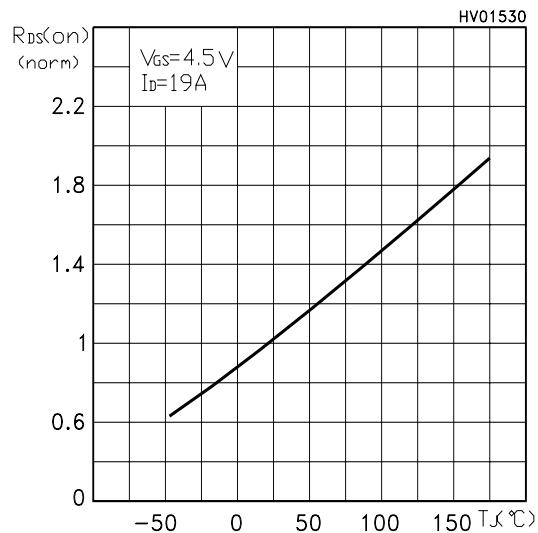
### Capacitance Variations



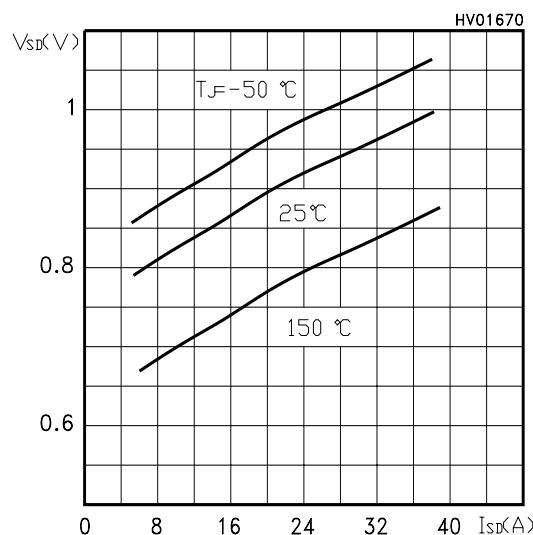
**Normalized Gate Threshold Voltage vs Temperature**



**Normalized On Resistance vs Temperature**

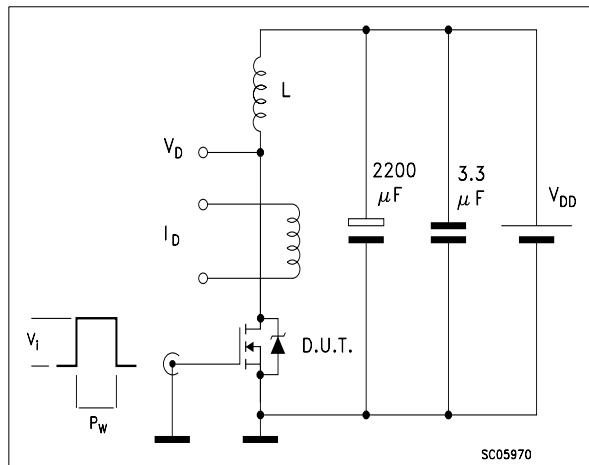


**Source-drain Diode Forward Characteristics**

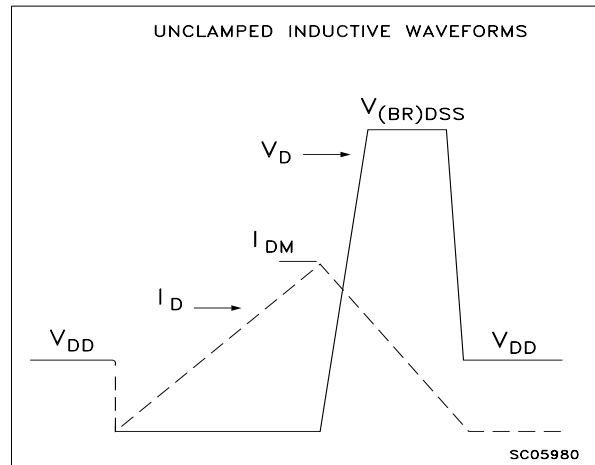


## STP45NF06L - STB45NF06L

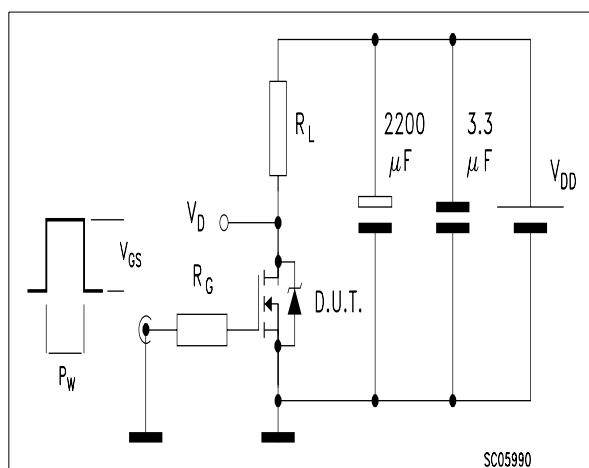
**Fig. 1:** Unclamped Inductive Load Test Circuit



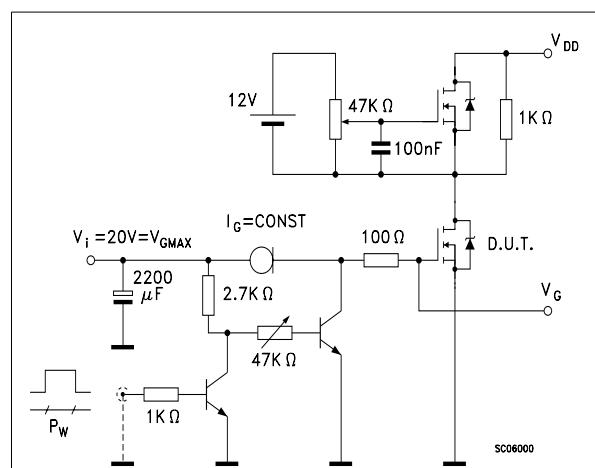
**Fig. 2:** Unclamped Inductive Waveform



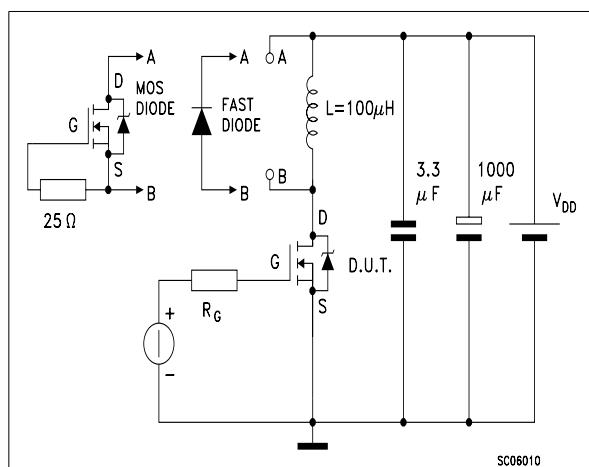
**Fig. 3:** Switching Times Test Circuit For Resistive Load



**Fig. 4:** Gate Charge test Circuit

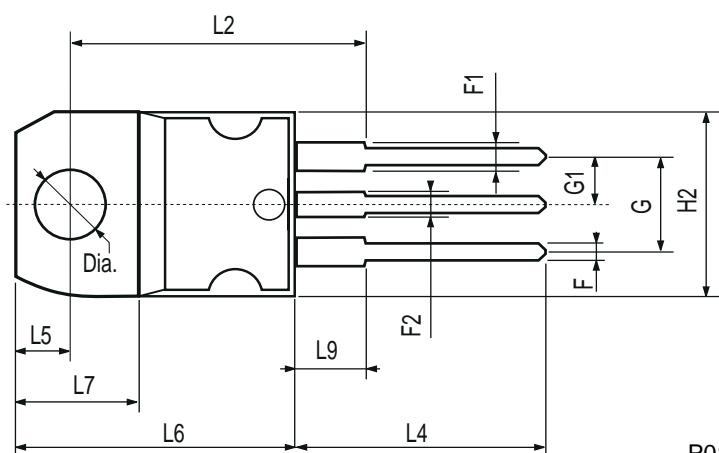
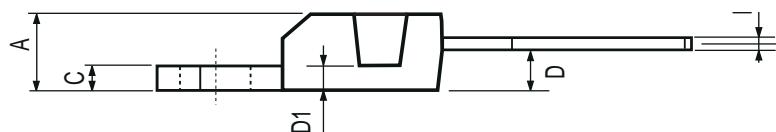


**Fig. 5:** Test Circuit For Inductive Load Switching And Diode Recovery Times



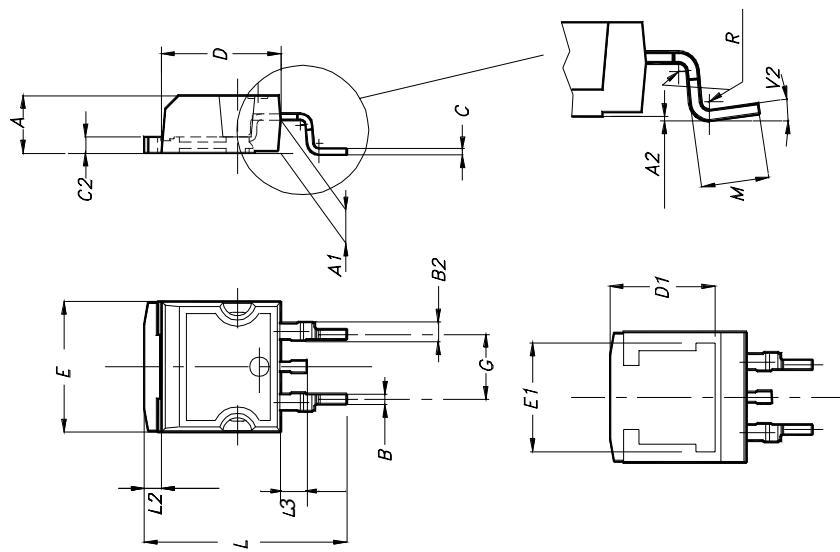
## TO-220 MECHANICAL DATA

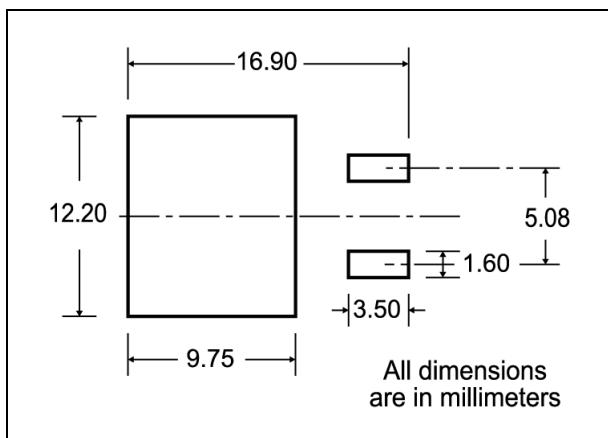
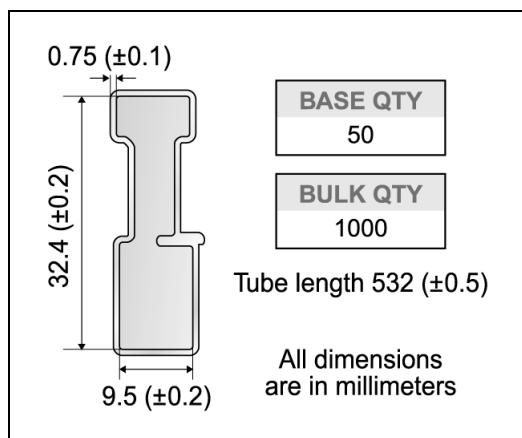
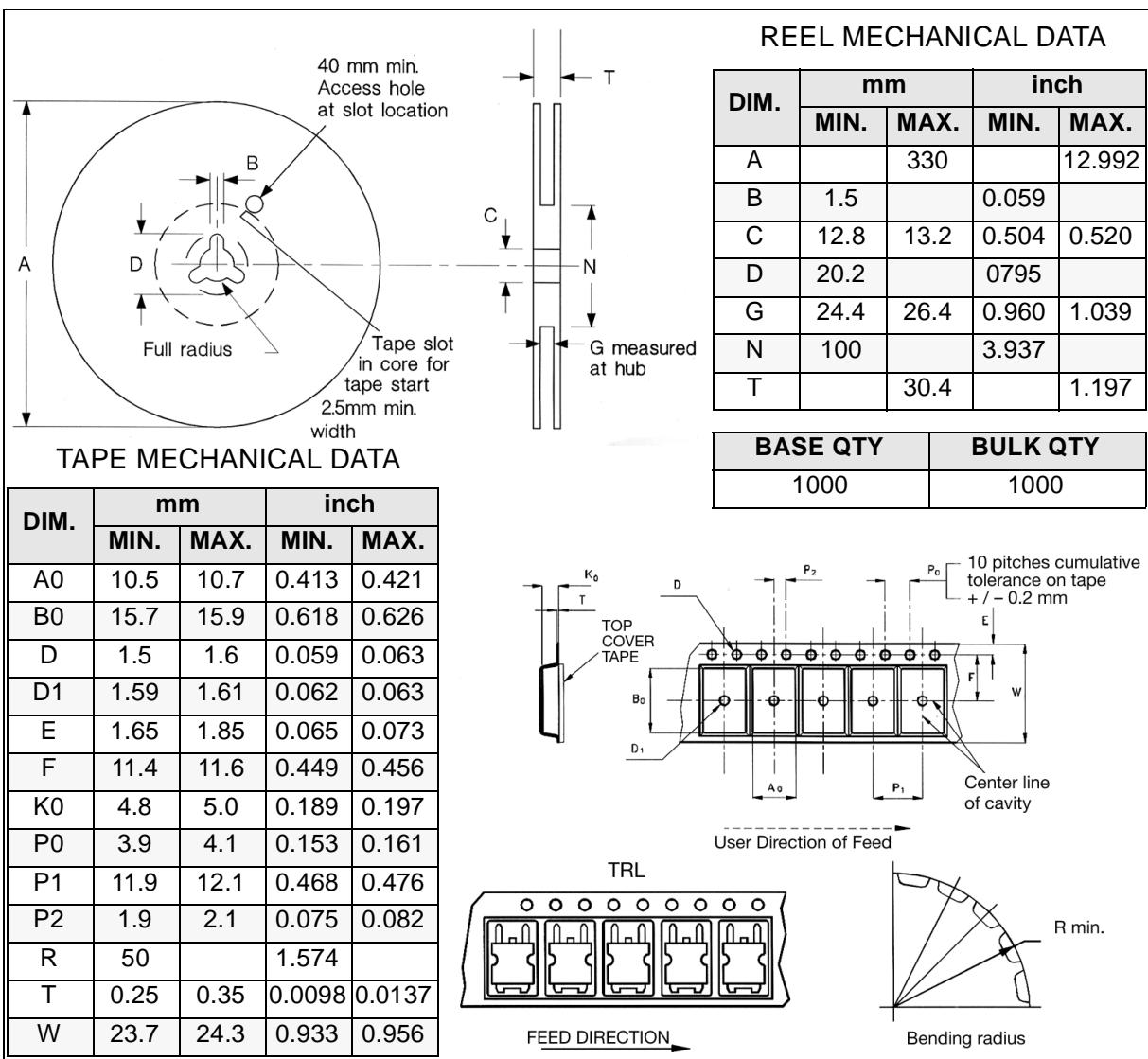
| DIM. | mm    |      |       | inch  |       |       |
|------|-------|------|-------|-------|-------|-------|
|      | MIN.  | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| A    | 4.40  |      | 4.60  | 0.173 |       | 0.181 |
| C    | 1.23  |      | 1.32  | 0.048 |       | 0.051 |
| D    | 2.40  |      | 2.72  | 0.094 |       | 0.107 |
| D1   |       | 1.27 |       |       | 0.050 |       |
| E    | 0.49  |      | 0.70  | 0.019 |       | 0.027 |
| F    | 0.61  |      | 0.88  | 0.024 |       | 0.034 |
| F1   | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| F2   | 1.14  |      | 1.70  | 0.044 |       | 0.067 |
| G    | 4.95  |      | 5.15  | 0.194 |       | 0.203 |
| G1   | 2.4   |      | 2.7   | 0.094 |       | 0.106 |
| H2   | 10.0  |      | 10.40 | 0.393 |       | 0.409 |
| L2   |       | 16.4 |       |       | 0.645 |       |
| L4   | 13.0  |      | 14.0  | 0.511 |       | 0.551 |
| L5   | 2.65  |      | 2.95  | 0.104 |       | 0.116 |
| L6   | 15.25 |      | 15.75 | 0.600 |       | 0.620 |
| L7   | 6.2   |      | 6.6   | 0.244 |       | 0.260 |
| L9   | 3.5   |      | 3.93  | 0.137 |       | 0.154 |
| DIA. | 3.75  |      | 3.85  | 0.147 |       | 0.151 |



**D<sup>2</sup>PAK MECHANICAL DATA**

| DIM. | mm.  |      |       | inch  |       |       |
|------|------|------|-------|-------|-------|-------|
|      | MIN. | TYP. | MAX.  | MIN.  | TYP.  | MAX.  |
| A    | 4.4  |      | 4.6   | 0.173 |       | 0.181 |
| A1   | 2.49 |      | 2.69  | 0.098 |       | 0.106 |
| A2   | 0.03 |      | 0.23  | 0.001 |       | 0.009 |
| B    | 0.7  |      | 0.93  | 0.027 |       | 0.036 |
| B2   | 1.14 |      | 1.7   | 0.044 |       | 0.067 |
| C    | 0.45 |      | 0.6   | 0.017 |       | 0.023 |
| C2   | 1.23 |      | 1.36  | 0.048 |       | 0.053 |
| D    | 8.95 |      | 9.35  | 0.352 |       | 0.368 |
| D1   |      | 8    |       |       | 0.315 |       |
| E    | 10   |      | 10.4  | 0.393 |       |       |
| E1   |      | 8.5  |       |       | 0.334 |       |
| G    | 4.88 |      | 5.28  | 0.192 |       | 0.208 |
| L    | 15   |      | 15.85 | 0.590 |       | 0.625 |
| L2   | 1.27 |      | 1.4   | 0.050 |       | 0.055 |
| L3   | 1.4  |      | 1.75  | 0.055 |       | 0.068 |
| M    | 2.4  |      | 3.2   | 0.094 |       | 0.126 |
| R    |      | 0.4  |       |       | 0.015 |       |
| V2   | 0°   |      | 8°    |       |       |       |



**D<sup>2</sup>PAK FOOTPRINT****TUBE SHIPMENT (no suffix)\*****TAPE AND REEL SHIPMENT (suffix "T4")\***

\* on sales type



## **STP45NF06L - STB45NF06L**

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